

SPECIFICATIONS

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:−40°c to +105°c

Contact Material:Brass

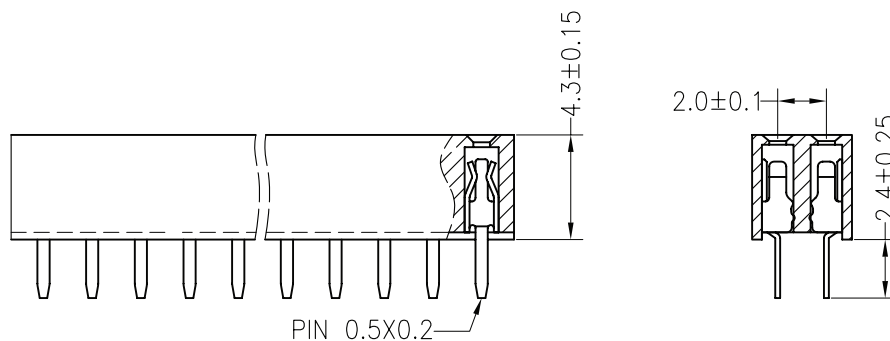
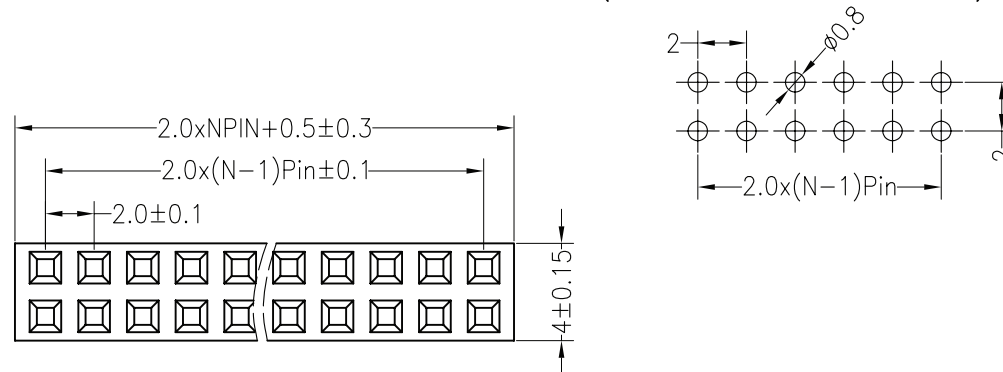
Contact Plating:Au Over Ni

Insulator Material:Polyester(UL94V−0)

Standard: PA6T

Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



FAMILY	PITCH	N° ROWS	N° PIN P.R.	VERSION	CLIP PLATING	HEIGHT	OPTION	PACKAGE
FH	200	2	XX	D [straight]	P [Bronze/Phosphor Gold Flash]	043	00 [Standard]	T [tube]
					R [Bronze Phosphor Gold Su']			V [tray/bag]



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UL
FILE N. E356435

UNITS: mm

SHEET SIZE: ISO A4

SCALE:

> 0 ~ 3

> 3 ~ 18

> 18 ~ 50

> 50 ~ 120

± 0.12

± 0.15

± 0.3

± 0.5



First angle projection

HEADER